

A	MS	Z Paden
4/22/2010	ECN-129761	
RELEASE FOR PRODUCTION		

DESIGNED & DIMENSIONED
IN INCHES[MILLIMETERS]

DPAF MATED TO DPAM

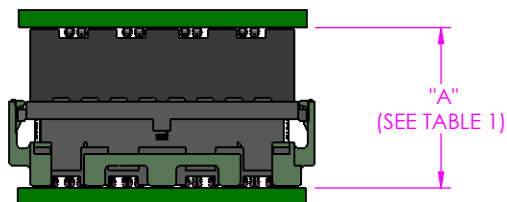


TABLE 1				
	Fully Mated Board To Board Dimension ("A")	Max Board to Board Dimension ("A")	Min Contact Wipe	Max Contact Wipe
DPAF/DPAM-14.0	.676 [17.17]	.724 [18.39]	.015 [0.381]	.063 [1.60]
DPAF/DPAM-11.0	.557 [14.15]	.601 [15.27]	.015 [0.381]	.059 [1.50]
DPAF/DPAM-07.0	.393 [9.98]	.441 [11.20]	.015 [0.381]	.063 [1.60]

NOTES:

1. ALL DIMENSIONS BASED ON NOMINAL VALUES FOR SAMTEC RECOMMENDED PCB LAYOUTS.
2. ALTHOUGH MAX DIMENSIONS ARE LISTED SAMTEC RECOMMENDS FULLY MATING COMPONENTS.

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